

National Semiconductor is now part of
Texas Instruments.

Search <http://www.ti.com/> for the latest technical
information and details on our current products and services.

LMC6081

Precision CMOS Single Operational Amplifier

General Description

The LMC6081 is a precision low offset voltage operational amplifier, capable of single supply operation. Performance characteristics include ultra low input bias current, high voltage gain, rail-to-rail output swing, and an input common mode voltage range that includes ground. These features, plus its low offset voltage, make the LMC6081 ideally suited for precision circuit applications.

Other applications using the LMC6081 include precision full-wave rectifiers, integrators, references, and sample-and-hold circuits.

This device is built with National's advanced Double-Poly Silicon-Gate CMOS process.

For designs with more critical power demands, see the LMC6061 precision micropower operational amplifier.

For a dual or quad operational amplifier with similar features, see the LMC6082 or LMC6084 respectively.

PATENT PENDING

Features

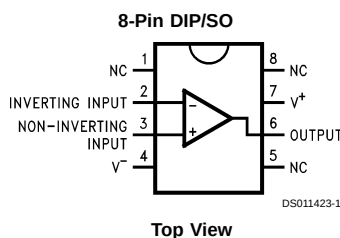
(Typical unless otherwise stated)

- Low offset voltage: 150 μ V
- Operates from 4.5V to 15V single supply
- Ultra low input bias current: 10 fA
- Output swing to within 20 mV of supply rail, 100k load
- Input common-mode range includes V^-
- High voltage gain: 130 dB
- Improved latchup immunity

Applications

- Instrumentation amplifier
- Photodiode and infrared detector preamplifier
- Transducer amplifiers
- Medical instrumentation
- D/A converter
- Charge amplifier for piezoelectric transducers

Connection Diagram



Ordering Information

Package	Temperature Range		NSC Drawing	Transport Media
	Military -55°C to +125°C	Industrial -40°C to +85°C		
8-Pin Molded DIP	LMC6081AMN	LMC6081AIN LMC6081IN	N08E	Rail
8-Pin Small Outline		LMC6081AIM LMC6081IM	M08A	Rail Tape and Reel

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Differential Input Voltage	±Supply Voltage
Voltage at Input/Output Pin	(V ⁺) +0.3V, (V ⁻) -0.3V
Supply Voltage (V ⁺ - V ⁻)	16V
Output Short Circuit to V ⁺	(Note 10)
Output Short Circuit to V ⁻	(Note 2)
Lead Temperature (Soldering, 10 Sec.)	260°C
Storage Temp. Range	-65°C to +150°C
Junction Temperature	150°C
ESD Tolerance (Note 4)	2 kV

Current at Input Pin	±10 mA
Current at Output Pin	±30 mA
Current at Power Supply Pin	40 mA
Power Dissipation	(Note 3)

Operating Ratings (Note 1)

Temperature Range	
LMC6081AM	-55°C ≤ T _J ≤ +125°C
LMC6081AI, LMC6081I	-40°C ≤ T _J ≤ +85°C
Supply Voltage	4.5V ≤ V ⁺ ≤ 15.5V
Thermal Resistance (θ _{JA}), (Note 11)	
N Package, 8-Pin Molded DIP	115°C/W
M Package, 8-Pin Surface Mount	193°C/W
Power Dissipation (Note 9)	

DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for T_J = 25°C. **Boldface** limits apply at the temperature extremes. V⁺ = 5V, V⁻ = 0V, V_{CM} = 1.5V, V_O = 2.5V and R_L > 1M unless otherwise specified.

Symbol	Parameter	Conditions	Typ (Note 5)	LMC6081AM Limit (Note 6)	LMC6081AI Limit (Note 6)	LMC6081I Limit (Note 6)	Units
V _{OS}	Input Offset Voltage		150	350 1000	350 800	800 1300	μV Max
TCV _{OS}	Input Offset Voltage Average Drift		1.0				μV/°C
I _B	Input Bias Current		0.010	100	4	4	pA Max
I _{OS}	Input Offset Current		0.005	100	2	2	pA Max
R _{IN}	Input Resistance		>10				Tera Ω
CMRR	Common Mode Rejection Ratio	0V ≤ V _{CM} ≤ 12.0V V ⁺ = 15V	85	75 72	75 72	66 63	dB Min
+PSRR	Positive Power Supply Rejection Ratio	5V ≤ V ⁺ ≤ 15V V _O = 2.5V	85	75 72	75 72	66 63	dB Min
-PSRR	Negative Power Supply Rejection Ratio	0V ≤ V ⁻ ≤ -10V	94	84 81	84 81	74 71	dB Min
V _{CM}	Input Common-Mode Voltage Range	V ⁺ = 5V and 15V for CMRR ≥ 60 dB	-0.4 V ⁺ - 1.9	-0.1 V ⁺ - 2.3 V⁺ - 2.6	-0.1 V ⁺ - 2.3 V⁺ - 2.5	-0.1 V ⁺ - 2.3 V⁺ - 2.5	V Max V Min
A _V	Large Signal Voltage Gain	R _L = 2 kΩ (Note 7)	Sourcing	1400 300	400 300	300 200	V/mV Min
			Sinking	350 70	180 100	90 60	V/mV Min
		R _L = 600Ω (Note 7)	Sourcing	1200 150	400 150	200 80	V/mV Min
			Sinking	150 35	100 50	70 35	V/mV Min

DC Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$. **Boldface** limits apply at the temperature extremes. $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{CM} = 1.5\text{V}$, $V_O = 2.5\text{V}$ and $R_L > 1\text{M}$ unless otherwise specified.

Symbol	Parameter	Conditions	Typ (Note 5)	LMC6081AM Limit (Note 6)	LMC6081AI Limit (Note 6)	LMC6081I Limit (Note 6)	Units
V_O	Output Swing	$V^+ = 5\text{V}$ $R_L = 2\text{ k}\Omega$ to 2.5V	4.87	4.80 4.70	4.80 4.73	4.75 4.67	V Min
			0.10	0.13 0.19	0.13 0.17	0.20 0.24	V Max
		$V^+ = 5\text{V}$ $R_L = 600\Omega$ to 2.5V	4.61	4.50 4.24	4.50 4.31	4.40 4.21	V Min
			0.30	0.40 0.63	0.40 0.50	0.50 0.63	V Max
		$V^+ = 15\text{V}$ $R_L = 2\text{ k}\Omega$ to 7.5V	14.63	14.50 14.30	14.50 14.34	14.37 14.25	V Min
			0.26	0.35 0.48	0.35 0.45	0.44 0.56	V Max
		$V^+ = 15\text{V}$ $R_L = 600\Omega$ to 7.5V	13.90	13.35 12.80	13.35 12.86	12.92 12.44	V Min
			0.79	1.16 1.42	1.16 1.32	1.33 1.58	V Max
		Sourcing, $V_O = 0\text{V}$ $V^+ = 5\text{V}$	22	16 8	16 10	13 8	mA Min
			21	16 11	16 13	13 10	mA Min
I_O	Output Current $V^+ = 15\text{V}$	Sourcing, $V_O = 0\text{V}$	30	28 18	28 22	23 18	mA Min
		Sinking, $V_O = 13\text{V}$ (Note 10)	34	28 19	28 22	23 18	mA Min
I_S	Supply Current	$V^+ = +5\text{V}$, $V_O = 1.5\text{V}$	450	750 900	750 900	750 900	μA Max
		$V^+ = +15\text{V}$, $V_O = 7.5\text{V}$	550	850 950	850 950	850 950	μA Max

AC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$, **Boldface** limits apply at the temperature extremes. $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{CM} = 1.5\text{V}$, $V_O = 2.5\text{V}$ and $R_L > 1\text{M}$ unless otherwise specified.

Symbol	Parameter	Conditions	Typ (Note 5)	LMC6081AM Limit (Note 6)	LMC6081AI Limit (Note 6)	LMC6081 Limit (Note 6)	Units
SR	Slew Rate	(Note 8)	1.5	0.8 0.5	0.8 0.6	0.8 0.6	V/ μs Min
GBW	Gain-Bandwidth Product		1.3				MHz
ϕ_m	Phase Margin		50				Deg
e_n	Input-Referred Voltage Noise	$F = 1\text{ kHz}$	22				nV/ $\sqrt{\text{Hz}}$
i_n	Input-Referred Current Noise	$F = 1\text{ kHz}$	0.0002				pA/ $\sqrt{\text{Hz}}$
T.H.D.	Total Harmonic Distortion	$F = 10\text{ kHz}$, $A_V = -10$ $R_L = 2\text{ k}\Omega$, $V_O = 8\text{ V}_{PP}$ $\pm 5\text{V}$ Supply	0.01				%

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 2: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C . Output currents in excess of $\pm 30\text{ mA}$ over long term may adversely affect reliability.

Note 3: The maximum power dissipation is a function of $T_{J(\text{Max})}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(\text{Max})} - T_A) / \theta_{JA}$.

Note 4: Human body model, $1.5\text{ k}\Omega$ in series with 100 pF .

Note 5: Typical values represent the most likely parametric norm.

Note 6: All limits are guaranteed by testing or statistical analysis.

Note 7: $V^+ = 15\text{V}$, $V_{CM} = 7.5\text{V}$ and R_L connected to 7.5V . For Sourcing tests, $7.5\text{V} \leq V_O \leq 11.5\text{V}$. For Sinking tests, $2.5\text{V} \leq V_O \leq 7.5\text{V}$.

Note 8: $V^+ = 15\text{V}$. Connected as Voltage Follower with 10V step input. Number specified is the slower of the positive and negative slew rates.

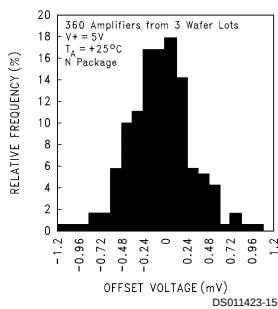
Note 9: For operating at elevated temperatures the device must be derated based on the thermal resistance θ_{JA} with $P_D = (T_J - T_A) / \theta_{JA}$.

Note 10: Do not connect output to V^+ , when V^+ is greater than 13V or reliability will be adversely affected.

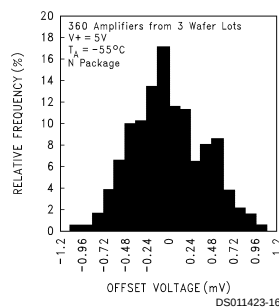
Note 11: All numbers apply for packages soldered directly into a PC board.

Typical Performance Characteristics $V_S = \pm 7.5\text{V}$, $T_A = 25^\circ\text{C}$, Unless otherwise specified

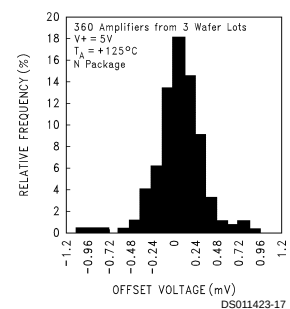
**Distribution of LMC6081
Input Offset Voltage
($T_A = +25^\circ\text{C}$)**



**Distribution of LMC6081
Input Offset Voltage
($T_A = -55^\circ\text{C}$)**

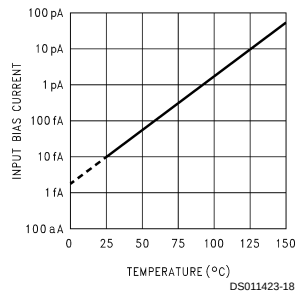


**Distribution of LMC6081
Input Offset Voltage
($T_A = +125^\circ\text{C}$)**

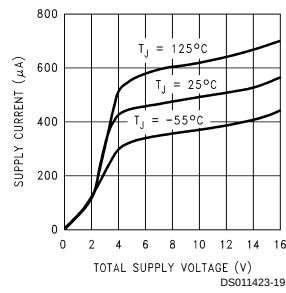


Typical Performance Characteristics $V_S = \pm 7.5V$, $T_A = 25^\circ C$, Unless otherwise specified (Continued)

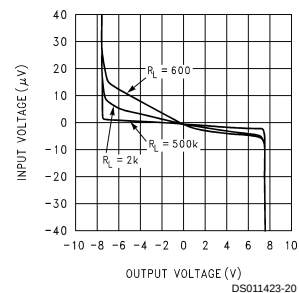
Input Bias Current vs Temperature



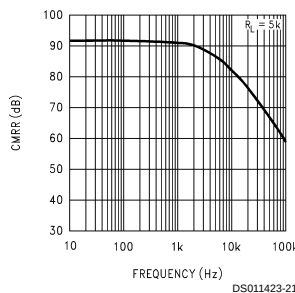
Supply Current vs Supply Voltage



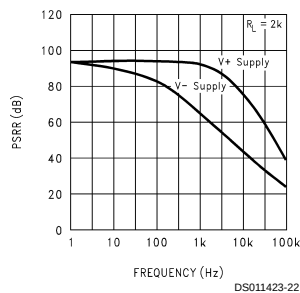
Input Voltage vs Output Voltage



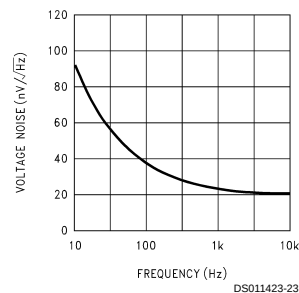
Common Mode Rejection Ratio vs Frequency



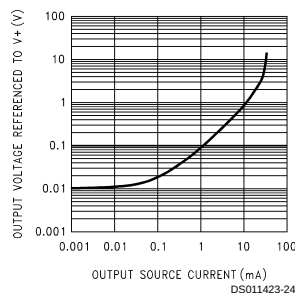
Power Supply Rejection Ratio vs Frequency



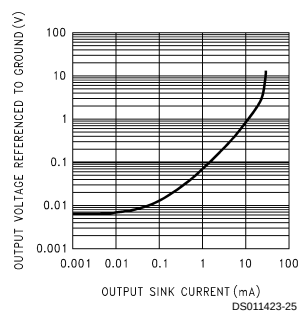
Input Voltage Noise vs Frequency



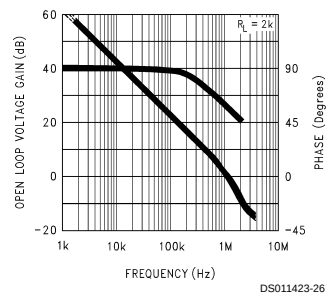
Output Characteristics Sourcing Current



Output Characteristics Sinking Current

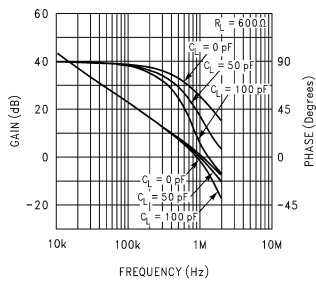


Gain and Phase Response vs Temperature (-55 °C to +125 °C)



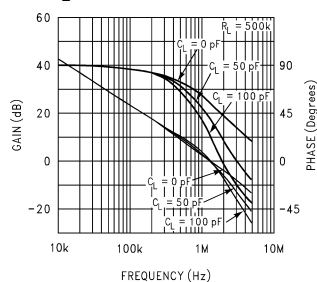
Typical Performance Characteristics $V_S = \pm 7.5V$, $T_A = 25^\circ C$, Unless otherwise specified (Continued)

Gain and Phase Response vs Capacitive Load with $R_L = 600\Omega$



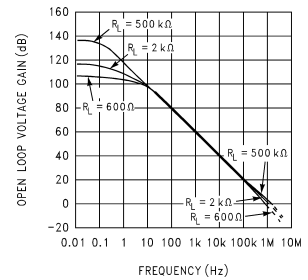
DS011423-27

Gain and Phase Response vs Capacitive Load with $R_L = 500k\Omega$



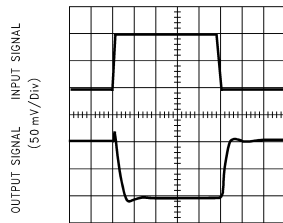
DS011423-28

Open Loop Frequency Response



DS011423-29

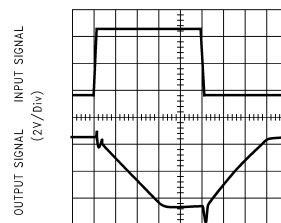
Inverting Small Signal Pulse Response



TIME (1 μs/Div)

DS011423-30

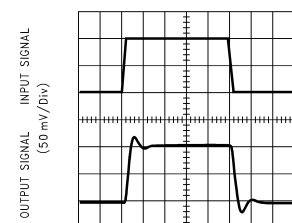
Inverting Large Signal Pulse Response



TIME (1 μs/Div)

DS011423-31

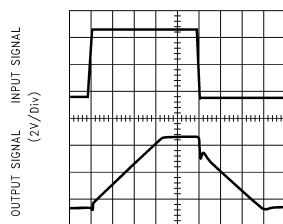
Non-Inverting Small Signal Pulse Response



TIME (1 μs/Div)

DS011423-32

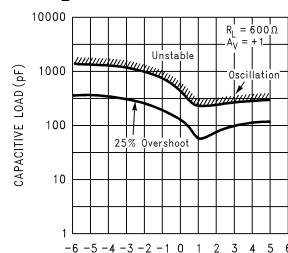
Non-Inverting Large Signal Pulse Response



TIME (1 μs/Div)

DS011423-33

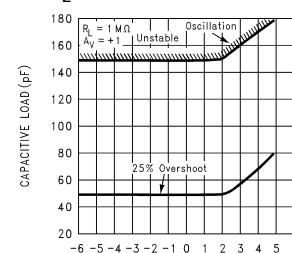
Stability vs Capacitive Load, $R_L = 600\Omega$



OUTPUT VOLTAGE (V)

DS011423-34

Stability vs Capacitive Load, $R_L = 1M\Omega$



OUTPUT VOLTAGE (V)

DS011423-35

Applications Hints

AMPLIFIER TOPOLOGY

The LMC6081 incorporates a novel op-amp design topology that enables it to maintain rail-to-rail output swing even when driving a large load. Instead of relying on a push-pull unity gain output buffer stage, the output stage is taken directly from the internal integrator, which provides both low output impedance and large gain. Special feed-forward compensation design techniques are incorporated to maintain stability over a wider range of operating conditions than traditional

micropower op-amps. These features make the LMC6081 both easier to design with, and provide higher speed than products typically found in this ultra-low power class.

COMPENSATING FOR INPUT CAPACITANCE

It is quite common to use large values of feedback resistance for amplifiers with ultra-low input current, like the LMC6081.

Applications Hints (Continued)

Although the LMC6081 is highly stable over a wide range of operating conditions, certain precautions must be met to achieve the desired pulse response when a large feedback resistor is used. Large feedback resistors and even small values of input capacitance, due to transducers, photo-diodes, and circuit board parasitics, reduce phase margins.

When high input impedances are demanded, guarding of the LMC6081 is suggested. Guarding input lines will not only reduce leakage, but lowers stray input capacitance as well. (See *Printed-Circuit-Board Layout for High Impedance Work*).

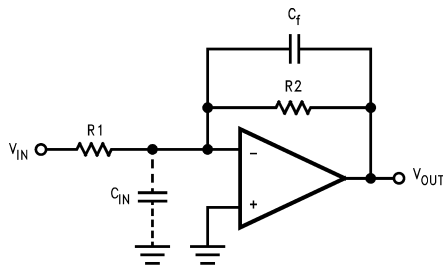
The effect of input capacitance can be compensated for by adding a capacitor, C_f , around the feedback resistors (as in *Figure 1*) such that:

$$\frac{1}{2\pi R_1 C_{IN}} \geq \frac{1}{2\pi R_2 C_f}$$

or

$$R_1 C_{IN} \leq R_2 C_f$$

Since it is often difficult to know the exact value of C_{IN} , C_f can be experimentally adjusted so that the desired pulse response is achieved. Refer to the LMC660 and LMC662 for a more detailed discussion on compensating for input capacitance.



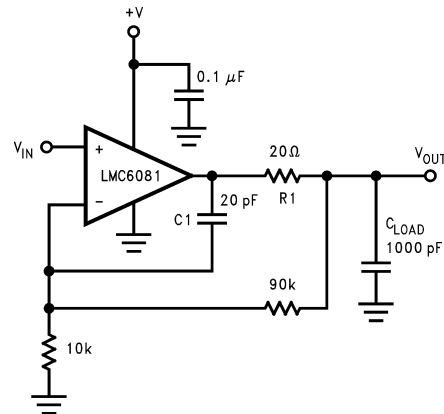
DS011423-4

FIGURE 1. Cancelling the Effect of Input Capacitance

CAPACITIVE LOAD TOLERANCE

All rail-to-rail output swing operational amplifiers have voltage gain in the output stage. A compensation capacitor is normally included in this integrator stage. The frequency location of the dominant pole is affected by the resistive load on the amplifier. Capacitive load driving capability can be optimized by using an appropriate resistive load in parallel with the capacitive load (see typical curves).

Direct capacitive loading will reduce the phase margin of many op-amps. A pole in the feedback loop is created by the combination of the op-amp's output impedance and the capacitive load. This pole induces phase lag at the unity-gain crossover frequency of the amplifier resulting in either an oscillatory or underdamped pulse response. With a few external components, op amps can easily indirectly drive capacitive loads, as shown in *Figure 2*.

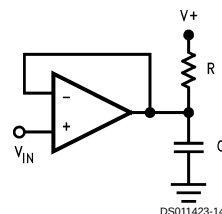


DS011423-5

FIGURE 2. LMC6081 Noninverting Gain of 10 Amplifier, Compensated to Handle Capacitive Loads

In the circuit of *Figure 2*, R_1 and C_1 serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

Capacitive load driving capability is enhanced by using a pull up resistor to V^+ (*Figure 3*). Typically a pull up resistor conducting 500 μA or more will significantly improve capacitive load responses. The value of the pull up resistor must be determined based on the current sinking capability of the amplifier with respect to the desired output swing. Open loop gain of the amplifier can also be affected by the pull up resistor (see electrical characteristics).



DS011423-14

FIGURE 3. Compensating for Large Capacitive Loads with a Pull Up Resistor

PRINTED-CIRCUIT-BOARD LAYOUT FOR HIGH-IMPEDANCE WORK

It is generally recognized that any circuit which must operate with less than 1000 pA of leakage current requires special layout of the PC board. When one wishes to take advantage of the ultra-low bias current of the LMC6081, typically less than 10 fA, it is essential to have an excellent layout. Fortunately, the techniques of obtaining low leakages are quite simple. First, the user must not ignore the surface leakage of the PC board, even though it may sometimes appear acceptably low, because under conditions of high humidity or dust or contamination, the surface leakage will be appreciable.

To minimize the effect of any surface leakage, lay out a ring of foil completely surrounding the LMC6081's inputs and the terminals of capacitors, diodes, conductors, resistors, relay terminals, etc. connected to the op-amp's inputs, as in *Fig-*

Applications Hints (Continued)

Figure 4. To have a significant effect, guard rings should be placed on both the top and bottom of the PC board. This PC foil must then be connected to a voltage which is at the same voltage as the amplifier inputs, since no leakage current can flow between two points at the same potential. For example, a PC board trace-to-pad resistance of $10^{12}\Omega$, which is normally considered a very large resistance, could leak 5 pA if the trace were a 5V bus adjacent to the pad of the input. This would cause a 100 times degradation from the LMC6081's actual performance. However, if a guard ring is held within 5 mV of the inputs, then even a resistance of $10^{11}\Omega$ would cause only 0.05 pA of leakage current. See Figure 5 for typical connections of guard rings for standard op-amp configurations.

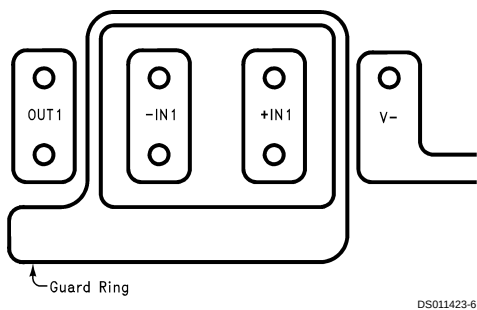
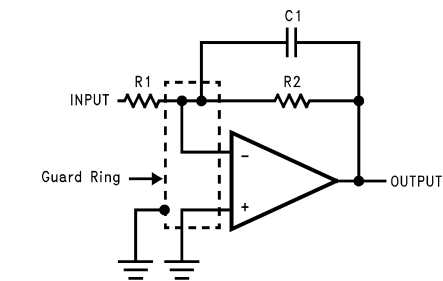
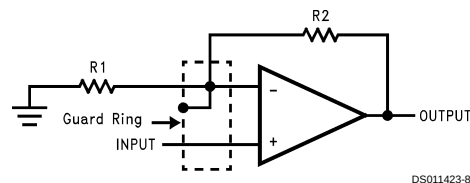


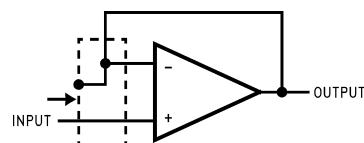
FIGURE 4. Example of Guard Ring in P.C. Board Layout



Inverting Amplifier



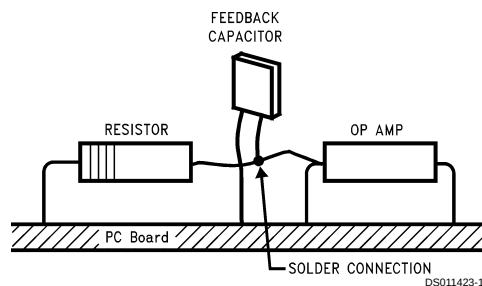
Non-Inverting Amplifier



Follower

FIGURE 5. Typical Connections of Guard Rings

The designer should be aware that when it is inappropriate to lay out a PC board for the sake of just a few circuits, there is another technique which is even better than a guard ring on a PC board: Don't insert the amplifier's input pin into the board at all, but bend it up in the air and use only air as an insulator. Air is an excellent insulator. In this case you may have to forego some of the advantages of PC board construction, but the advantages are sometimes well worth the effort of using point-to-point up-in-the-air wiring. See Figure 6.



(Input pins are lifted out of PC board and soldered directly to components. All other pins connected to PC board).

FIGURE 6. Air Wiring

Latchup

CMOS devices tend to be susceptible to latchup due to their internal parasitic SCR effects. The (I/O) input and output pins look similar to the gate of the SCR. There is a minimum cur-

Latchup (Continued)

rent required to trigger the SCR gate lead. The LMC6061 and LMC6081 are designed to withstand 100 mA surge current on the I/O pins. Some resistive method should be used to isolate any capacitance from supplying excess current to the I/O pins. In addition, like an SCR, there is a minimum holding current for any latchup mode. Limiting current to the supply pins will also inhibit latchup susceptibility.

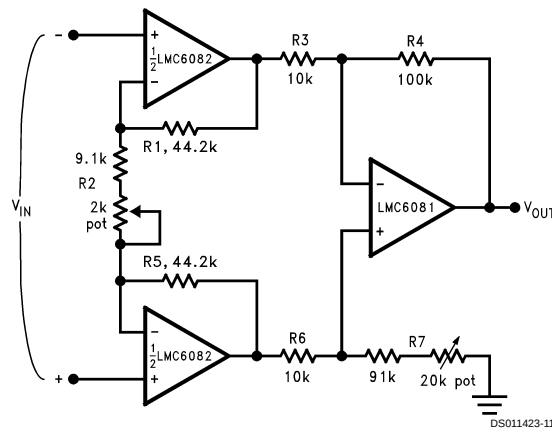
Typical Single-Supply Applications

($V^+ = 5.0 V_{DC}$)

The extremely high input impedance, and low power consumption, of the LMC6081 make it ideal for applications that

require battery-powered instrumentation amplifiers. Examples of these types of applications are hand-held pH probes, analytic medical instruments, magnetic field detectors, gas detectors, and silicon based pressure transducers.

Figure 7 shows an instrumentation amplifier that features high differential and common mode input resistance ($>10^{14}\Omega$), 0.01% gain accuracy at $A_V = 1000$, excellent CMRR with 1 k Ω imbalance in bridge source resistance. Input current is less than 100 fA and offset drift is less than 2.5 $\mu V/^{\circ}C$. R_2 provides a simple means of adjusting gain over a wide range without degrading CMRR. R_7 is an initial trim used to maximize CMRR without using super precision matched resistors. For good CMRR over temperature, low drift resistors should be used.



If $R_1 = R_5$, $R_3 = R_6$, and $R_4 = R_7$, then

$$\frac{V_{OUT}}{V_{IN}} = \frac{R_2 + 2R_1}{R_2} \times \frac{R_4}{R_3}$$

$A_V = 100$ for circuit shown ($R_2 = 9.822k$).

FIGURE 7. Instrumentation Amplifier

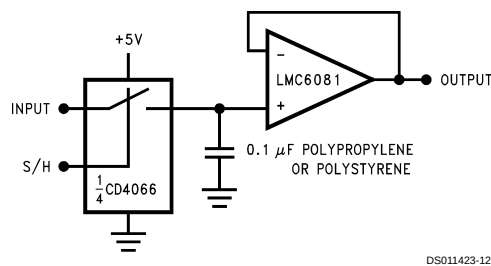
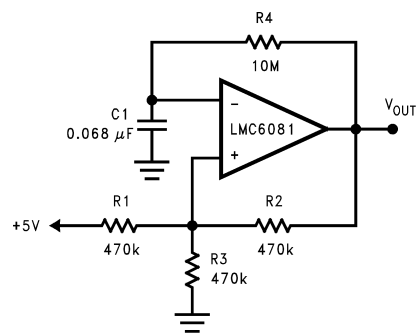


FIGURE 8. Low-Leakage Sample and Hold

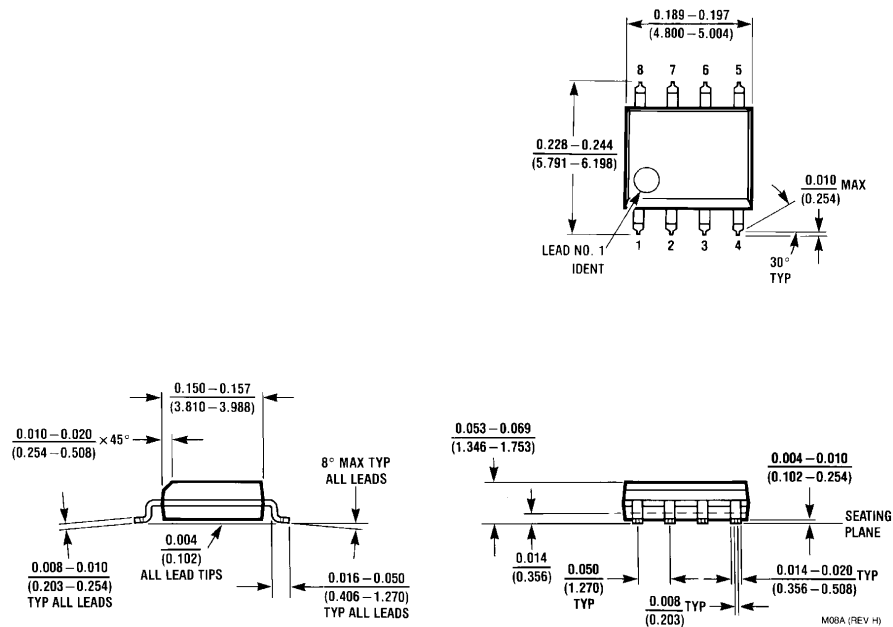
Typical Single-Supply Applications (Continued)



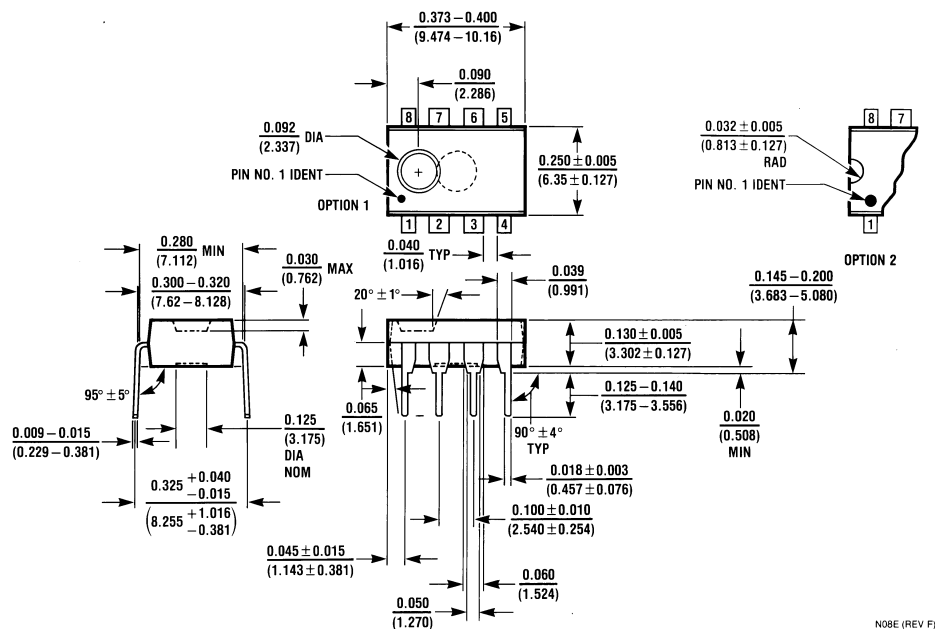
DS011423-13

FIGURE 9. 1 Hz Square Wave Oscillator

Physical Dimensions inches (millimeters) unless otherwise noted



8-Pin Small Outline Package
Order Number LMC6081AIM or LMC6081IM
NS Package Number M08A



8-Pin Molded Dual-In-Line Package
Order Number LMC6081AIN, LMC6081AMN or LMC6081IN
NS Package Number N08E

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation
Americas
Tel: 1-800-272-9959
Fax: 1-800-737-7018
Email: support@nsc.com

www.national.com

National Semiconductor Europe
Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 1 80-530 85 85
English Tel: +49 (0) 1 80-532 78 32
Français Tel: +49 (0) 1 80-532 93 58
Italiano Tel: +49 (0) 1 80-534 16 80

National Semiconductor Asia Pacific Customer Response Group
Tel: 65-2544466
Fax: 65-2504466
Email: sea.support@nsc.com

National Semiconductor Japan Ltd.
Tel: 81-3-5639-7560
Fax: 81-3-5639-7507

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.